CALL FOR PAPERS

The IEEE International Conference on Flexible Electronics and Systems (ICFES) is the flagship conference of IEEE-SMC TC on Flexible Electronics Systems, TC on Bio-mechatronics and Bio-robotics Systems, and IEEE-RAS TC on Neuro-Robotics Systems. The ICFES 2024 will be organized by City University of Hong Kong, China, and held in Hong Kong, from December 12th to 14th, 2024. The conference will provide an international forum for researchers, educators, and engineers in general areas of electrical engineering, materials science, computer science, and robotics to disseminate their latest research results and exchange views on the future research directions of these fields.

Topics of Interest:
- Flexible electronics
- Flexible and soft systems
- Novel materials for sensing and actuation systems
- Multi-sensor data fusion and intelligent sensor fusion
- Soft, skin-like electronic and bionic systems
- Computational intelligence in sensing
- Intelligent robotic systems based on flexible electronics
- Skin-like human-robot interface
- Advanced materials for flexible sensor fabrication
- Soft robotics
- Flexible and biocompatible sensors and actuators

Important Dates
- 15 JULY 2024: Full papers and organized session proposals
- 31 JULY 2024: Proposal for tutorials and workshops
- 15 August 2024: Notification of paper and session acceptance
- 15 September 2024: Submission of final papers in IEEE PDF